

PATENT ASSIGNMENT

Electronic Version v1.1

Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT										
NATURE OF CONVEYANCE:	ASSIGNMENT										
CONVEYING PARTY DATA											
<table border="1"><thead><tr><th>Name</th><th>Execution Date</th></tr></thead><tbody><tr><td>Je-Hun LEE</td><td>12/03/2007</td></tr><tr><td>Chang-Oh JEONG</td><td>12/03/2007</td></tr><tr><td>Eun-Guk LEE</td><td>12/03/2007</td></tr><tr><td>Do-Hyun KIM</td><td>12/03/2007</td></tr></tbody></table>	Name	Execution Date	Je-Hun LEE	12/03/2007	Chang-Oh JEONG	12/03/2007	Eun-Guk LEE	12/03/2007	Do-Hyun KIM	12/03/2007	
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Chang-Oh JEONG	12/03/2007										
Eun-Guk LEE	12/03/2007										
Do-Hyun KIM	12/03/2007										
RECEIVING PARTY DATA											
Name:	Samsung Electronics Co., Ltd.										
Street Address:	#416, Maetan-dong,										
Internal Address:	Yeongtong-gu, Suwon-si,										
City:	Gyeonggi-do										
State/Country:	KOREA, REPUBLIC OF										
PROPERTY NUMBERS Total: 1											
<table border="1"><thead><tr><th>Property Type</th><th>Number</th></tr></thead><tbody><tr><td>Application Number:</td><td>11961149</td></tr></tbody></table>	Property Type	Number	Application Number:	11961149							
Property Type	Number										
Application Number:	11961149										
CORRESPONDENCE DATA											
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NAME OF SUBMITTER:	Hugh H. Matsubayashi										
Total Attachments: 2											

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PATENT
REEL: 020276 FRAME: 0763

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ASSIGNMENT

For good and valuable consideration, receipt of which is hereby acknowledged, I/We

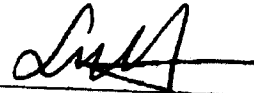
Je-Hun LEE	of	401 Daeil Villa, #724-12, Mok 4-dong, Yangcheon-gu, Seoul, Korea
Chang-Oh JEONG	of	201-203 Dongsuwon LG Village 2 Cha, Mangpo- dong, Yeongtong-gu, Suwon-si, Gyeonggi-do, Korea
Eun-Guk LEE	of	404-1802 Geumhwa Maeul Jugong Apt., Sanggal- dong, Giheung-gu, Yongin-si, Gyeonggi-do, Korea
Do-Hyun KIM	of	204-1002 Yuwon 2 Cha Apt., #7-2 Dangsan-dong 5-ga, Yeongdeungpo-gu, Seoul, Korea

hereby sell, assign and transfer to **SAMSUNG ELECTRONICS CO., LTD.**, a corporation, having a place of business at 416, Maetan-dong, Yeongtong-gu, Suwon-si, Gyeonggi-do, Korea, its successors and assigns, the entire right, title and interest throughout the world in our invention in

WIRE STRUCTURE, METHOD FOR FABRICATING WIRE, THIN FILM TRANSISTOR SUBSTRATE, AND METHOD FOR FABRICATING THE THING FILM TRANSISTOR SUBSTRATE

for which I have executed a United States patent application on or about the date of this assignment, and all patent applications and patents of every country for said invention, including divisions, reissues, continuations and extensions thereof, and all rights of priority resulting from the filing of said applications; I authorize the above-named assignee to apply for patents of foreign countries for said invention, and to claim all rights of priority without further authorization from me; I agree to execute all papers useful in connection with said United States and foreign applications, and generally to do everything possible to aid said assignee, its successors, assigns and nominees, at their request and expense, in obtaining and enforcing patents for said invention in all countries; and I request that the United States Patent and Trademark Office issue all patents granted for said invention to the above-named assignee, its successors and assigns.

Executed this 3 day of 12, 2007.



Je-Hun LEE

Executed this 3 day of 12, 2007.



Chang-Oh JEONG

Executed this 3 day of 12, 2007.



Eun-Guk LEE

Executed this 2 day of 12, 2007.



Do-Hyun KIM

PATENT